# **Product Summary**

V <sub>(BR)DSS</sub>	R <sub>DS(on)TYP</sub>	l <sub>D</sub>
200V	18mΩ@10V	70A



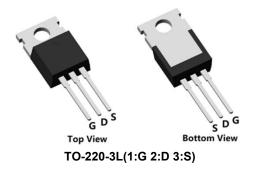
#### **Feature**

- Fast Switching
- Low Gate Charge and Rdson
- 100% Single Pulse avalanche energy Test

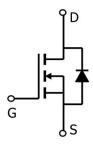
## **Applications**

- Power switching application
- DC-DC Converter
- Power Management

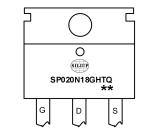
### **Package**



## Circuit diagram



## Marking



SP020N18GHTQ : Product code \*\* : Week code

#### **Order Information**

Device	Package	Unit/Tube
SP020N18GHTQ	TO-220-3L	50

200V N-Channel Power MOSFET

# Absolute maximum ratings (Ta=25°C,unless otherwise noted)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V <sub>DS</sub>	200	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Continuous Drain Current (Tc=25°C)	I <sub>D</sub>	70	Α
Continuous Drain Current (Tc=100°C)	I <sub>D</sub>	47	Α
Pulsed Drain Current	I <sub>DM</sub>	280	Α
Single Pulse Avalanche Energy <sup>1</sup>	Eas	840	mJ
Power Dissipation (Tc=25°C)	P <sub>D</sub>	300	W
Thermal Resistance Junction-to-Case	R <sub>eJC</sub>	0.42	°C/W
Storage Temperature Range	T <sub>STG</sub>	-55 to 150	$^{\circ}$
Operating Junction Temperature Range	TJ	-55 to 150	$^{\circ}$

## Electrical characteristics (Ta=25°C, unless otherwise noted)

Characteristics	Symbol	Test Condition	Min	Тур	Max	Unit
Static Characteristics					•	
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	VGS=0V , ID=250uA	200	-	-	V
Drain Cut-Off Current	IDSS	VDS=160V , VGS=0V , TJ=25℃	-	-	1	uA
Gate Leakage Current	I <sub>GSS</sub>	VGS=±20V , VDS=0V	-	-	±100	nA
Gate Threshold Voltage	V <sub>GS(th)</sub>	VGS=VDS , ID =250uA	2	3	4	V
Drain-Source ON Resistance	R <sub>DS(ON)</sub>	VGS=10V , ID=20A	-	18	22.5	mΩ
Dynamic Characteristics						
Input Capacitance	Ciss	VDS=100V , VGS=0V , f=1MHz	-	3264	-	
Output Capacitance	Coss		-	197	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>	1		14	-	1
Total Gate Charge	Qg		-	42.9	-	nC
Gate-Source Charge	Q <sub>gs</sub>	VDS=100V , VGS=10V , ID=35A	-	19	-	
Gate-Drain Charge	Q <sub>gd</sub>	1 [		6.9	-	
Switching Characteristics						
Turn-On Delay Time	t <sub>d(on)</sub>		-	45	-	
Rise Time	tr	VDD=100V, VGS=10V , RG=10Ω, ID=35A	-	46	-	
Turn-Off Delay Time	t <sub>d(off)</sub>		-	79	-	nS
Fall Time	t <sub>f</sub>	1		19	-	
Drain-Source Body Diode Characteri	stics					
Source-Drain Diode Forward Voltage	V <sub>SD</sub>	VGS=0V , IS=1A , TJ=25℃	-	-	1.2	V
Maximum Body-Diode Continuous Current	Is		-	-	70	Α
Reverse Recovery Time	Trr	I <sub>s</sub> =35A, di/dt=100A/us, TJ=25℃		136	-	nS
Reverse Recovery Charge	Qrr			393	-	nC

#### Note:

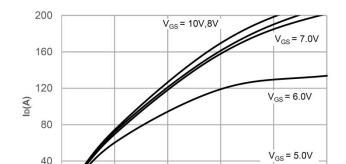
1. The EAS test condition is VDD=50V,VGS=10V,L=0.5mH,RG=25 $\Omega$ 

40

0

0

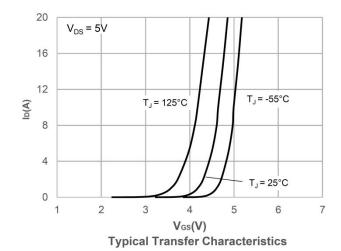
## **Typical Characteristics**

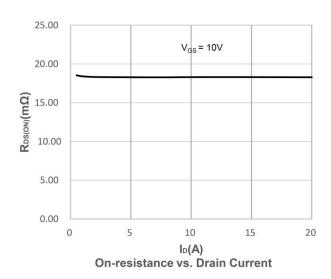


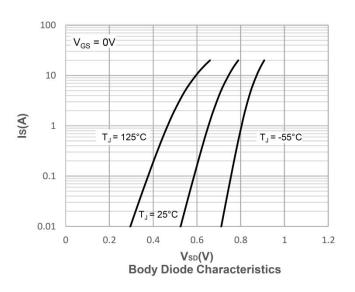
V<sub>DS</sub>(V)

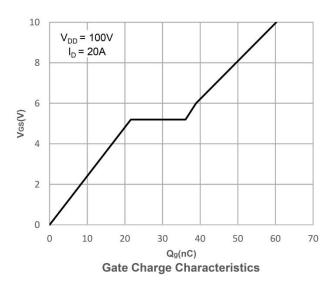
**Output Characteristics** 

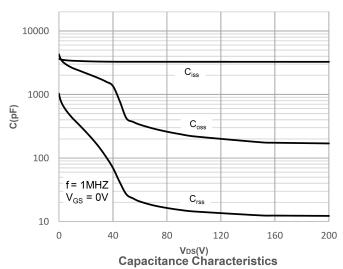
 $V_{GS} = 4.5V$ 



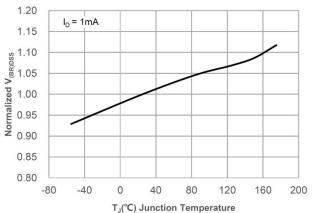




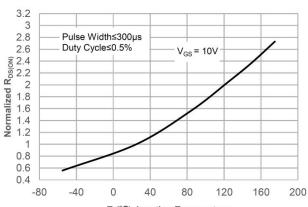




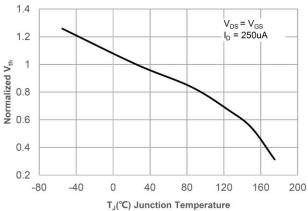




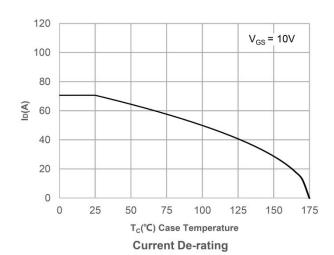
Normalized Breakdown voltage vs. Junction
Temperature

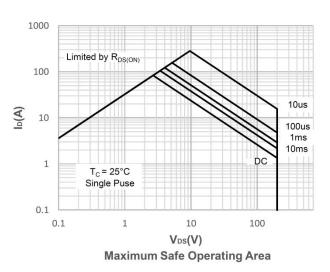


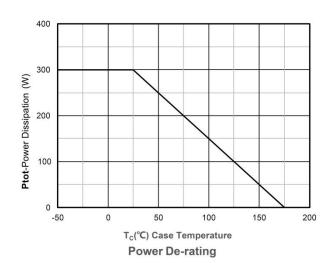
T<sub>J</sub>(°C) Junction Temperature Normalized on Resistance vs. Junction Temperature



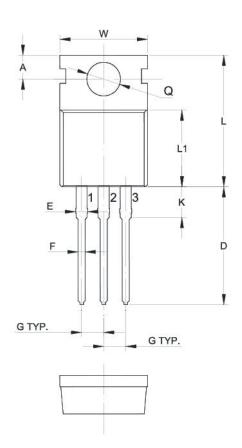
Normalized Threshold Voltage vs. Junction
Temperature

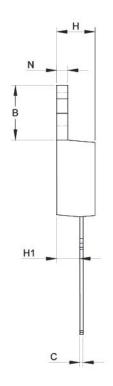


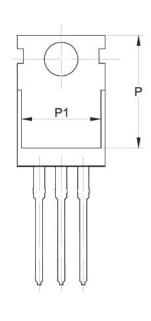












Cumbal	Dimensions In Millimeters		
Symbol	Min.	Max.	
А	2.700	2.900	
В	6.400	6.800	
С	0.300	0.700	
D	11	15	
E	1.1	1.5	
F	0.7	0.9	
G	2.54TYP		
W	9.8	10.2	
Н	4.3	4.7	
H1	2.2	2.5	
K	2.7	3.1	
L	14.8	16.8	
L1	9.0	9.4	
N	1.2 1.4		
Р	12.7 13.3		
P1	7.6 8.2		
Q	3.5	3.7	